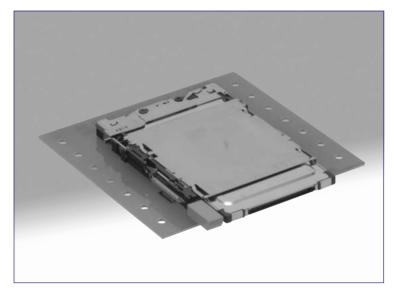
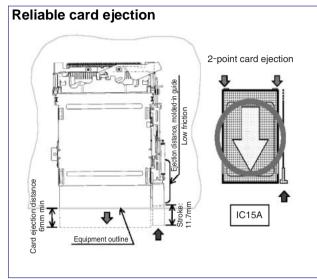
PC Card Single Slot SMT Connectors for the AV Market (that Support 5 V Cards)

IC15 Series





Features

1. Reliable card ejection

Designed for the front mounted Audio/Visual equipment the connectors eject the inserted card by applying force equally at each edge of the card (distance of 6 mm minimum), allowing easy hold of the card for the final removal.

2. New three-stage "Pop-Up" card ejection mechanism

The button does not protrude without the card being inserted, preventing it's damage when carrying the portable devices.

3. Secure board retention

Built-in 4 points of board retention posts assure that the card insertion shock is not transferred to the solder joints.

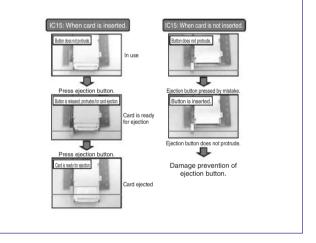
4. Supports lead-free environments

All components use lead-free materials.

Applications

DVD recorders, LCD TVs, PDP and other digital AV equipment

Three-stage card ejection



Product Specifications

| | Current rating | 0.5A | Operating temperature range | -55℃ to +85℃ (Note 1) | Storage temperature range | -40℃ to +70℃ (Note 1) |
|---------|----------------|---------|-----------------------------|---|---------------------------|-----------------------|
| Ratings | Voltage rating | 125V AC | Operating humidity range | Relative humidity 95% max. (No condensation) | Storage humidity range | 40% to 70% (Note 1) |

| Item | Specifications | Conditions | | |
|---------------------------------|---|--|--|--|
| 1. Insulation resistance | 100 MΩ min. | 500 V DC | | |
| 2. Withstanding voltage | No flashover or insulation breakdown. | 500 V AC / one minute | | |
| 3. Contact resistance | 60 mΩ max. (Initial value) | 1mA DC | | |
| 4. Vibration | No clostrical discontinuity of 100 no or more | Frequency: 10 to 2000 Hz, single amplitude of 1.52 mn | | |
| 4. VIDIATION | No electrical discontinuity of 100 ns or more. | acceleration of 147m/s ² (peak), 4 hours / 3 axis | | |
| 5. Humidity | Insulation resistance: 100 MΩ min. | 96 hours at temperature of 40°C±2°C and humidity of 90% to 95% | | |
| | Insulation resistance: 100 MQ min. | Temperature: $-55^{\circ} \rightarrow +5^{\circ} \rightarrow +35^{\circ} \rightarrow +85^{\circ} \rightarrow +5^{\circ} \rightarrow +35^{\circ}$ | | |
| 6. Temperature cycle | Insulation resistance: 100 Mg min. | Duration: $30 \rightarrow 5 \text{ max}$. $\rightarrow 30 \rightarrow 5 \text{ max}$. (Minutes) 5 cycles | | |
| 7. Durability (mating/unmating) | Contact resistance: 20m max. from initial value | 10000 cycles at 400 to 600 cycles per hour | | |
| 9 Desistance to coldering heat | No deformation of any component. No offect on contests | Reflow: At the recommended temperature profile | | |
| 8.Resistance to soldering heat | No deformation of any component. No affect on contacts. | Manual soldering: 300 °C for 3 seconds | | |

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non- conducting condition of installed connectors in storage, shipment or during transportation.

■Materials/Finish

SMT unit

| Component | Material | Finish | Remarks | |
|-----------------------------|---------------------------------------|------------------------------|---------|--|
| Insulator | Heat resistant thermoplastic compound | Color: Black | UL94V-0 | |
| Contacts | Brass | Contact area: Gold plated | | |
| Contacts | Blass | Termination area: Tin plated | | |
| Ground/eject metal fittings | Stainless steel | | | |
| Positioning pin | Brass | Tin plated | | |

Guide unit

| Component | Material | Finish | Remarks |
|------------------------|-----------------|--------------|----------|
| Frame | PBT | Color: Black | UL94V-0 |
| Cover/Metal components | Stainless | | |
| Spring | Stainless steel | | |
| Ejection button | ABS | Color: Gray | UL94V-HB |

Note: Lead free products

Ordering information

| 1T unit | $\frac{IC15}{0} \frac{A}{2} - \frac{PDR}{6}$ | $-\frac{SF}{4} = \frac{M}{6} - \frac{EJL}{6}$ |
|---------|--|---|
| 1 | Series name: IC15 | 4 SF: Right angle surface mount |
| 2 | Stand off height A: 2.2mm | 6 M: With Vacuum pick-up plate6 Ejection button type |
| 8 | Terminal type PDR: Reverse type (5V type) | EJL: Left button eject |

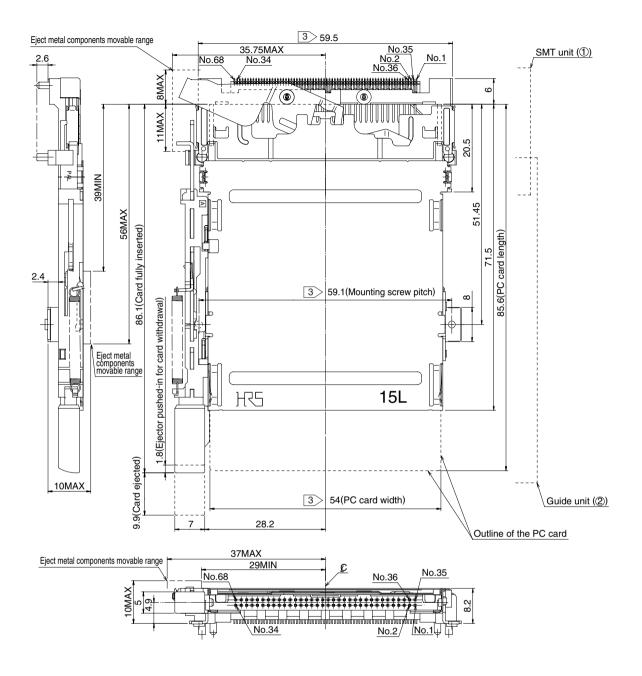
• Guide unit

| | | | | - | - | | |
|---|------------------|----|---|---|-----------------------|------------------|--|
| | | 7 | 8 | 9 | 0 | • | |
| 7 | Series name:IC15 | | | 1 | Eject mechanism codes | | |
| 8 | Stand off height | | | | P: Pop | -up button | |
| | A: 2.2mm | mm | | 1 | | n button type | |
| 9 | G: Guide unit | | | | EJL: Le | eft button eject | |

IC15 A - G - P EJL

Note: One SMT unit and one Guide unit constitute one assembly. They can not be ordered separate.

Reverse type Left Pop-up button type



| Stand off height | SMT uni | t (1) | Guide | Weight (g) | | |
|------------------|-------------------|--------------|--------------------------|--------------|------------|--|
| Stand on height | Part Number | CL No. | Part Number | CL No. | weight (g) | |
| 2.2mm | IC15A-PDR-SF-EJL | CL640-1500-7 | IC15A-G-PEJL CL640-1503- | | 18.4 | |
| 2.2000 | IC15A-PDR-SFM-EJL | CL640-1502-2 | | CL040-1505-5 | 18.7 | |

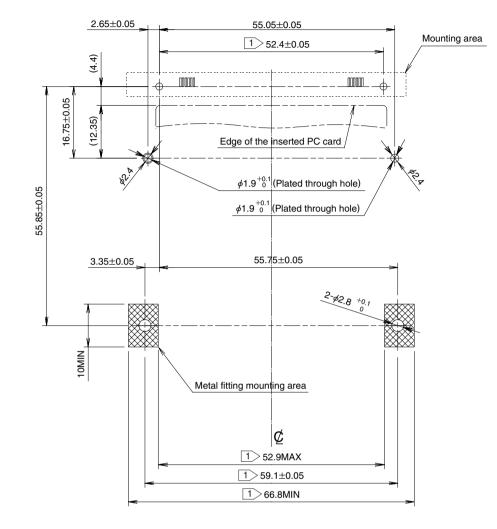
1: Above illustration shows the SMT unit and the Guide unit connected together.

2: Dimensions for card fitting are in accordance with "PC card standard".

3 Indicated dimensions are symmetrical to the center of the card insertion slot.

♦ PCB mounting pattern

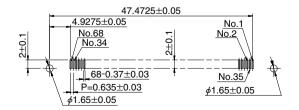
- Reverse type
 - Stand off 2.2mm



Note $\underline{1}$ Indicated dimensions are symmetrical to the center of the card insertion slot.

●PCB mounting pattern (Enlarged detail)

Reverse type





Method of Attachment to the Board and Precautions

- (1) Exercise caution when handling the Guide unit.
 - If needed, re-position the push rod or the stroke arm as indicated in Fig.1

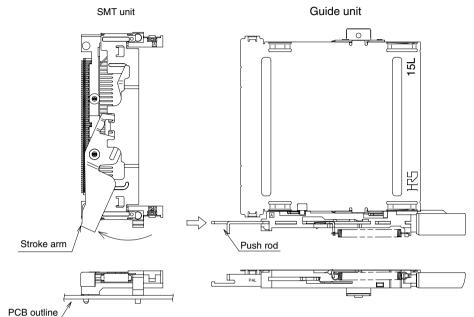
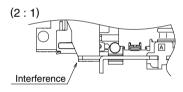


Fig. 1



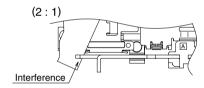


Fig. 2

(2) Align the left and right locking tabs (Fig. 4) of the Guide unit shield plate with the left and right openings on the SMT unit insulator. (Fig. 3)

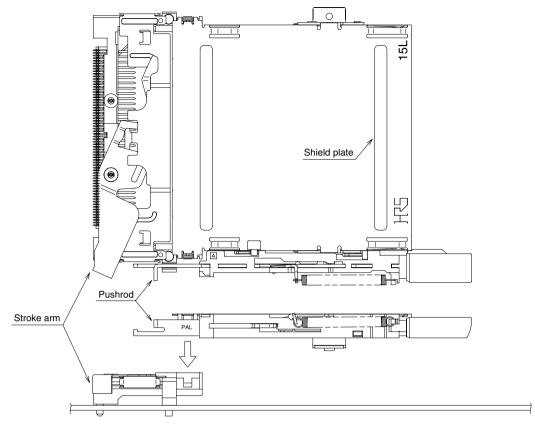
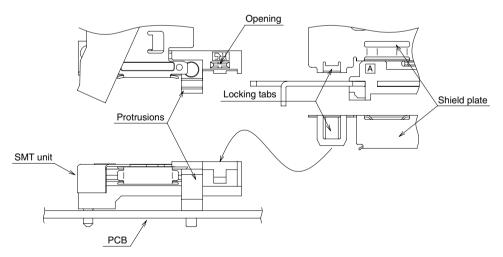
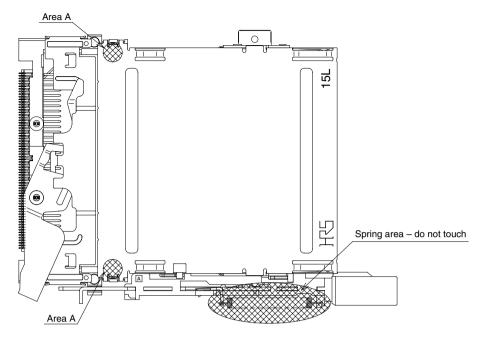


Fig. 3



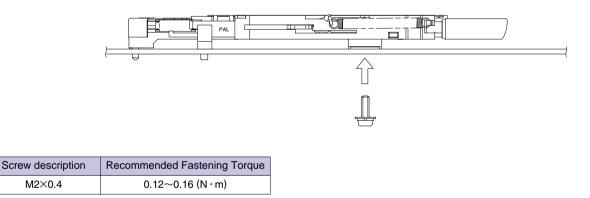


- (3) Assuring the correct alignment firmly press-down the shield plate of the Guide unit (at the areas "A") into the SMT unit until a
 - loud "click" sound is heard. Both units should be now firmly locked together.



Note 1: When placing the Guide unit over the SMT unit, DO NOT press on any other area than "A".

(4) Attach the Guide unit in two places using recommended screws (Not supplied).



Note 2: When attaching the screws exercise caution not to deform the shield plate.

M2×0.4

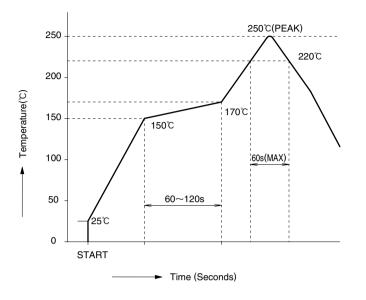
Note 3: Do not insert/eject the PC card before the SMT unit and the Guide unit are fully mounted and locked.

Note 4: Metal components of these connector assemblies have sharp edges. Use caution when handling and assembling.

Note 5: Slight tool marks or cleaning fluid residue on the surfaces of the Guide unit will not affect form, fit or function of the assemblies.



Recommended temperature profile



Recommended conditions

- · Reflow system: IR reflow
- · Solder composition: Paste, 96.5%Sn/3.0%Ag/0.5%Cu (Flux content 10.5wt%)
- Test board: Glass epoxy 80mm×125mm×1.6mm thick
- Metal mask: 0.15mm thick

The temperature profiles are based on the above conditions.

In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.





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